SPEC. NO	.:	96	REV :	
DATE :	2008.04	4.31		
PRODUCT	Г NAME :	Switchable	Receptacle Conne	ector
PRODUCT	Г NO:	C90-101-X	XXX	
	SPEED 桃園縣龜山鄉民	TECH 生北路一段 568 號	CORP.	
	SPEED 桃園縣龜山鄉民 NO. 568, SEC.1 KWEI-SHAN-HSL TAIWAN, R.O.C. TEL : 0086-7 FAX : 0086-7	TECH 生北路一段 568 號 1, MIN-HSIEN N RO ANG, TAO-YUAN H 55-83953433 55-83953438	CORP. AD., SIEN,	DCC
	SPEED 桃園縣龜山鄉民 NO. 568, SEC.1 KWEI-SHAN-HSL TAIWAN, R.O.C. TEL : 0086-7 FAX : 0086-7	TECH 生北路一段 568 號 1, MIN-HSIEN N RO ANG, TAO-YUAN H 55-83953433 55-83953438 CHECKED	CORP. AD., SIEN, PREPARED	DCC ISSUI

Product Number: C90-101-XXXX

Product Description: Switchable Receptacle Connector

1. SCOPE

1.1. Content

This specification covers performance, tests and quality requirements for switchable receptacle connector. These connectors are used to switch signal between internal antenna and external inspection equipment.

2. APPLICABLE DOCUMENTS

The following documents form a part of this specification to the extent specified herein. Unless otherwise specified, latest edition of the specification applies. In the event of conflict between requirements of this specification and product drawing, product drawing shall take precedence.

2.1. Commercial standards, specifications and report

2.1.1. MIL-STD-1344A

3. REQUIREMENTS

3.1. Design and Construction

Product shall be of design, construction and physical dimensions specified on applicable product drawing.

3.2. Green product requirement

All of GP product shall be mated ROHS notices and substances (Level 1) forbidden.

3.3. Materials and Finish

3.3	3.1. Contact Finish	 : High performance : (a) Contact Area: (b) Other area: Go (c) Underplate: 50 	copper alloy Gold 5u" min. o old flush)u" min. Nickel j	n contact area			
3.3 3.3	3.2. Housing3.3. CoverFinish	 : Nylon, color in bla : High performance : (a) Contact Area: (b) Other area: Go 	ack, UL94V-0 ra copper alloy Gold 5u" min. o old flush	n contact area			
3.4. Ra 3.4	tings .1. R	(c) Underplate: 50 ated Voltage: AC 36)u" min. Nickel j Vrms	plated all over			
SPEC NO.:	SPEC0396	REV.: C	ECN NO. :	EN0608116	PAGE :	1 / 8	

- 3.4.2. Nominal Characteristic Impedance: 50Ω
- 3.4.3. Frequency: DC~6GHz
- 3.4.4. VSWR: 1.2 max. under 3GHz, 1.3 max. 3GHz~6GHz,
- 3.4.5. Service Temperature: $-40 \sim +90^{\circ}$ C
- 3.5. Performance and Test Description

Product is designed to meet electrical, mechanical and environmental performance requirements specified in Paragraph 3.6. All tests are performed at ambient environmental conditions per MIL-STD-1344A unless otherwise specified.

3.6. Test Requirements and Procedures Summary

Test Description	Requiremen	nt	Procedure				
Examination of Product	Product shall meet requirements of applic product drawing and specification.	able	Visual, dimensional and functional per applicable quality inspection plan.				
	ELE	CTRIC					
Low-Signal Level Contact Resistance	Point1 to point2: $50 \text{ m}\Omega$ Max. initial $120 \text{ m}\Omega$ Max. final		MIL-STD-1344A, Method 3002.1 Frequency: 1kHz Current: 100mA max. Voltage drop: 20mV max.				
Insulation Resistance	500 M Ω minimum in	iitial	MIL-STD-1344A, Method 3003.1 Apply DC 250±10% Volts between the inner contacts and the outer contact for one minute.				
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 0.5 mA max.		MIL-STD-1344A, Method 3001.1, Test Condition I Apply AC 300+/-20V Vrms between the signal contacts and the ground contact for one minute.				
VSWR	1.2 max. DC~3GHz, 1 3GHz~6GHz,	1.2 max. DC~3GHz, 1.3 max. 3GHz~6GHz,		Measurement method refer Fig. 1 See Note (a).			
Isolation	20dB (DC~3GHz), 15dB (3GHz~6GHz)		Measurement method refer Fig. 2 See Note (a).				
Insertion Loss	0.1dB max. (DC~3GHz), 0.2dB max. (3GHz~6GHz)		Measurement method refer Fig. 3 See Note (a).				
MECHANICAL							
SPEC NO.: SPEC039	6 REV.: C	ECN NO.	.: EN0608116	PAGE : 2 / 8			

Mating / Unmating	Mating: 30N Max.		Mate connector with	a suitable gauge at			
Force	Unmating: 3N Min.		rate of 25 mm/min. Measure force when				
	40N Max.		gauge reaches surface of connector.				
			MIL-STD-1344A, M	lethod 2012.1			
Durability	500 cycles. See Note	(b).	The sample should tester and fully mate number of cycles spe 12 cycles/min MIL_STD-1344A_M	be mounted in the ed and unmated the ecified at the rate of			
Vibration, Random	No electrical disconting greater than 1 μ secon See Note (b).	nuity d.	The electrical load com mA maximum for a to a simple harmonic amplitude of 1.5m total excursion) in fr limits of 10 and 5 frequency range, from return to 10 Hz, sl approximately 2 ho shall be applied for three mutually perpent MIL-STD-1344A, M	ondition shall be 100 ll contacts. Subject ic motion having an m (3mm maximum equency between the 55 Hz. The entire om 10 to 55 Hz and hall be traversed in purs. This motion 1 cycles in each of ndicular directions. Iethod 2005.1			
Physical Shock	No electrical discontin greater than 1 μ secon See Note (b).	nuity d.	Subject mated recep 75 G's (peak value pulses of 6 mile Three shocks in each applied along the perpendicular axes of (18 shocks). The condition shall be 1 all contacts. MIL-STD-1344A, Ma Condition E	ptacle connectors to ue) half-sine shock liseconds duration. ch direction shall be e three mutually of the test specimen the electrical load 00mA maximum for lethod 2004.1,			
	1						
SPEC NO.: SPEC039	6 REV.: C	ECN NO	.: EN0608116	PAGE : 3 / 8			

Intensity of bend	No ez termi	No excoriation of electrode terminal Soldering test sample with test PCB, Measurement as follows. 1. Thickness of PCB :1.6mm 2. Speed :1.0mm/s 3. Bend :1.0mm 4. Time :30s 5. Direction of force 6. Solder paste : Sn 60%, Pt 7. Thickness of solder paste :150 μ					
		ENVIR	ONME	NTAL			
Temperature Cycling	See Note (b).			Apply the following environment to the mating connector $-40^{\circ}C(30\text{min.}) \rightarrow +20\sim35^{\circ}C(5\text{min.}) \rightarrow$ $+85^{\circ}C(30\text{min.}) \rightarrow +20\sim35^{\circ}C(5\text{min.})$ Transition time: 5min., 50 cycles MTL-STD-1344A, Method 1003.1			
Humidity	See Note (b).			Subject mated receptacle connectors to humidity of $+60^{\circ}$ C and 95% RH for 96 hours. Measurements should be done within 2 hours after removal from humidity. MIL-STD-1344A, Method 1002.2			
Solderability	Solderable area shall have minimum of 95% solder coverage.		nave ler	Subject the test area of contacts into flux for $5\sim10$ seconds and then into solder bath, controlled at $260\pm5^{\circ}$ C, for 3 ± 0.5 seconds. EIA-364-52.			
Resistance to Soldering Heat	No physical abnormalities shall be present after the test.		ities shall st.	Convection reflow condition: Refer to Fig. 4			
				Work done by hand: Subject the test area of contacts into flux for 5~10 seconds and then into solder bath, controlled at 350±5°C, for 3±0.5 seconds. EIA-364-56.			
SPEC NO.: SPEC0396 REV.: C ECN NO. : EN0608116 PAGE : 4 / 8							

- (a) It must using reflow soldering to mount DUT on the PCB, the detail of soldering condition refer to Fig. 4
- (b) Shall meet visual requirements, show no physical damage and shall meet requirements of additional tests as specified in Test Sequence in Figure 1.

3.7. Product Qualification and Test S	Sequenc	e							
		Test Group							
Test or Examination		2	3	4	5	6	7		
	Test Sequence								
Examination of Product	1,7	1,6	1,10	1	1,3	1,3	1,3		
Low-Signal Level Contact Resistance	2,6	2,5	2,7						
Insulation Resistance			3,8						
Dielectric Withstanding Voltage			4,9						
VSWR				2					
Isolation				4					
Insertion Loss				3					
Vibration		3							
Physical Shock		4							
Mating / Unmating Force									
Durability	4								
Temperature Cycling			5						
Humidity			6						
Intensity of bend							2		
Solderability					2				
Resistance to Soldering Heat						2			
Sample Size		5	5	5	3	5	5		
Figure 1									
SPEC NO.: SPEC0396 REV.: C	EC	CN NO	.: E	EN0608	116	PAGE	: 6	/ 8	







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